

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
KATE WEN	07/02/2014
YAZHOU WANG	07/03/2014
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<b>Street Address:</b>	BUILDING 8, 388 JIALILUE RODA
<b>Internal Address:</b>	ZHANGJIANG HI-TECH PARK
<b>City:</b>	SHANGHAI
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	201203
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14374278
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<b>DATE SIGNED:</b>	09/23/2014
<b>Total Attachments: 3</b>	
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source=Chinese_inventors_to_Sundia#page3.tif	

## ASSIGNMENT

WHEREAS, we/I:

Kate Wen, residing at:

200 Song Tao Rd., 50/101  
Shanghai,  
China, 201203

and

Yazhou Wang, residing at:

76 Chuan Huan South Road, Building 4, Apt. 501  
Pudong New District  
Shanghai 201299  
China

hereinafter referred to as ASSIGNOR(S), have/has made a new invention entitled

“PDE9 inhibitors with imidazo triazinone backbone”

for which International Patent Application No. PCT/EP2013/051451 was filed on 25 January 2013;

WHEREAS, Sundia MediTech Company, Ltd., Building 8, 388 Jialilue Roda, Zhangjiang Hi-Tech Park, Shanghai 201203, China, hereinafter referred to as ASSIGNEE, is desirous of obtaining the entire interest, right and title to said application;

NOW, THEREFORE, for good and valuable consideration, [we/I], the ASSIGNOR(S), do hereby assign, transfer and set over unto the ASSIGNEE, its respective successors, legal representatives and assignees, the entire right, title and interest in, the following in any country and/or region:

- a) the Application, all corresponding applications, including, but not limited to, divisional applications, continuations thereof, all Letters Patents which may be granted thereon and all reissues, re-examinations and extensions thereof,
- b) and all applications for Letters Patent that may hereafter be filed for improvements and all Letters Patents that may be granted for improvements in any country and/or region and all reissues, re-examinations and extensions thereof;

AND [WE/I] HEREBY acknowledge that this assignment includes the right of ASSIGNEE to apply for and obtain any and all Letters Patent, and to have said Letters Patent granted, in ASSIGNEE's own name.

AND [WE/I] HEREBY represent that we/I have full right to assign, transfer and set over the entire interest, right and title herein assigned, and that we/I have not signed, and will not sign, any agreement in conflict herewith.

AND [WE/I] HEREBY acknowledge the duty to disclose to the United States Patent and Trademark Office all information which is material to patentability as defined in 37 CFR §1.56 and to disclose to the Patent Offices of other jurisdictions all relevant material as required by their Patent Laws.

AND [WE/I] HEREBY further agree that we/I will, with respect to the Application and any improvements, in all countries and regions:

- a) communicate to the ASSIGNEE, its successors, legal representative and assignees any facts known to us/me ;
- b) testify in any legal proceeding,
- c) sign all lawful papers,
- d) make all rightful oaths,
- e) and generally aid the ASSIGNEE, its successors, legal representatives and assignees to obtain and enforce proper patent protection.

Shanghai, 7/2/2014  
Place and date

Kate Wen  
Kate Wen

Shanghai 7/3/2014  
Place and date

Yazhou Wang  
Yazhou Wang